

## Austin Minilynx<sup>™</sup> 12V SMT Non-isolated Power Modules: 8.3 – 14Vdc input; 0.75Vdc to 5.5 Vdc Output; 3A Output Current



## **Applications**

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Servers and storage applications
- Networking equipment
- Enterprise Networks
- Latest generation IC's (DSP, FPGA, ASIC) and Microprocessor powered applications

## **Features**

- Compliant to RoHS EU Directive 2002/95/EC (-Z versions)
- Compliant to ROHS EU Directive 2002/95/EC with lead solder exemption (non-Z versions)
- Delivers up to 3A output current
- High efficiency 91% at 3.3V full load (V<sub>IN</sub> = 12.0V)
- Small size and low profile:
  - 20.3 mm x 11.4 mm x 7.27 mm
- (0.80 in x 0.45 in x 0.286 in)
- Low output ripple and noise
- Constant switching frequency (300 kHz)
- Output voltage programmable from 0.75 Vdc to 5.5 Vdc via external resistor
- Line Regulation: 0.3% (typical)
- Load Regulation: 0.4% (typical)
- Temperature Regulation: 0.4 % (typical)
- Remote On/Off
- Output overcurrent protection (non-latching)
- Wide operating temperature range (-40°C to 85°C)
- UL\* 60950-1Recognized, CSA<sup>†</sup> C22.2 No. 60950-1-03 Certified, and VDE<sup>‡</sup> 0805:2001-12 (EN60950-1) Licensed
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities

## **Description**

Austin MiniLynx<sup>TM</sup> 12V SMT (surface mount technology) power modules are non-isolated dc-dc converters that can deliver up to 3A of output current with full load efficiency of 91% at 3.3V output. These modules provide precisely regulated output voltage programmable via external resistor from 0.75Vdc to 5.5Vdc over a wide range of input voltage ( $V_{IN} = 8.3 - 14V$ ). Their open-frame construction and small footprint enable designers to develop cost- and space-efficient solutions. In addition to sequencing, standard features include remote On/Off, programmable output voltage and over current protection.

<sup>\*</sup> UL is a registered trademark of Underwriters Laboratories, Inc.

<sup>&</sup>lt;sup>†</sup> CSA is a registered trademark of Canadian Standards Association.

<sup>&</sup>lt;sup>‡</sup> VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
\*\* ISO is a registered trademark of the International Organization of Standards

## Austin MiniLynx<sup>™</sup> 12V SMT Non-isolated Power Modules: 8.3 - 14Vdc input; 0.75Vdc to 5.5Vdc Output; 3A output current

## **Absolute Maximum Ratings**

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage	All	V <sub>IN</sub>	-0.3	15	Vdc
Continuous					
Operating Ambient Temperature	All	T <sub>A</sub>	-40	85	°C
(see Thermal Considerations section)					
Storage Temperature	All	T <sub>stg</sub>	-55	125	°C

## **Electrical Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Мах	Unit
Operating Input Voltage	V <sub>o,set</sub> ≤ 3.63	V <sub>IN</sub>	8.3	12	14	Vdc
	V <sub>o,set</sub> > 3.63	V <sub>IN</sub>	8.3	12	13.2	Vdc
Maximum Input Current	All	I <sub>IN,max</sub>			2.2	Adc
(V_{IN}=V_{IN, min} to V_{IN, max}, I_O=I_{O, max} V_{O,set} = 3.3 Vdc)						
Input No Load Current	V <sub>O,set</sub> = 0.75Vdc	I <sub>IN,No load</sub>		45		mA
$(V_{IN} = V_{IN, nom} Vdc, I_0 = 0, module enabled)$	V <sub>O,set</sub> = 5.5Vdc	I <sub>IN,No load</sub>		150		mA
Input Stand-by Current	All	I <sub>IN,stand-by</sub>		1.2		mA
( $V_{IN}$ = 5.5Vdc, module disabled)						
Inrush Transient	All	l <sup>2</sup> t			0.4	A <sup>2</sup> s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 1µH source impedance; $V_{IN, min}$ to $V_{IN, max}$ , $I_0$ = $I_{Omax}$ ; See Test configuration section)	All			30		mAp-p
Input Ripple Rejection (120Hz)	All			30		dB

## CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to being part of a complex power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fastacting fuse with a maximum rating of 6 A (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data sheet for further information.

## Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point	All	V <sub>O, set</sub>	-2.5	V <sub>O, set</sub>	+2.5	% V <sub>O, set</sub>
(V <sub>IN</sub> = <sub>IN, min</sub> , I <sub>O</sub> =I <sub>O, max</sub> , T <sub>A</sub> =25°C)						
Output Voltage	All	V <sub>O, set</sub>	-3%		+4%	% V <sub>O, set</sub>
(Over all operating input voltage, resistive load, and temperature conditions until end of life)						
Adjustment Range Selected by an external resistor	All	Vo	0.7525		5.5	Vdc
Output Regulation						
Line ( $V_{IN}=V_{IN, min}$ to $V_{IN, max}$ )	All		_	0.3	_	% V <sub>O, set</sub>
Load ( $I_0=I_{O, min}$ to $I_{O, max}$ )	All		_	0.4	_	% V <sub>O, set</sub>
Temperature ( $T_{ref}=T_{A, min}$ to $T_{A, max}$ )	All		_	0.4	_	% V <sub>O, set</sub>
Output Ripple and Noise on nominal output						
$(V_{IN}=V_{IN, nom} \text{ and } I_O=I_{O, min} \text{ to } I_{O, max}$						
Cout = 1µF ceramic//10µFtantalum capacitors)						
RMS (5Hz to 20MHz bandwidth)	All		_	10	15	mV <sub>rms</sub>
Peak-to-Peak (5Hz to 20MHz bandwidth)	All		_	30	50	mV <sub>pk-pk</sub>
External Capacitance						
ESR ≥ 1 mΩ	All	C <sub>O, max</sub>	_	_	1000	μF
ESR ≥ 10 mΩ	All	C <sub>O, max</sub>	_	_	3000	μF
Output Current	All	I <sub>o</sub>	0		3	Adc
Output Current Limit Inception (Hiccup Mode)	All	I <sub>O, lim</sub>	_	200	_	% I₀
(V <sub>O</sub> = 90% of V <sub>O, set</sub> )						
Output Short-Circuit Current	All	I <sub>O, s/c</sub>	_	2	_	Adc
(V₀≤250mV) ( Hiccup Mode )						
Efficiency	V <sub>o,set</sub> = 1.2Vdc	η		81.5		%
V <sub>IN</sub> = V <sub>IN, nom</sub> , T <sub>A</sub> =25°C	V <sub>O, set</sub> = 1.5Vdc	η		84.0		%
I <sub>O</sub> =I <sub>O, max</sub> , V <sub>O</sub> = V <sub>O,set</sub>	V <sub>O,set</sub> = 1.8Vdc	η		86.0		%
	V <sub>o,set</sub> = 2.5Vdc	η		89.0		%
	V <sub>o,set</sub> = 3.3Vdc	η		91.0		%
	V <sub>o,set</sub> = 5.0Vdc	η		93.0		%
Switching Frequency	All	f <sub>sw</sub>	_	300	_	kHz
Dynamic Load Response						
(dlo/dt=2.5A/µs; V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C)	All	V <sub>pk</sub>	_	200	—	mV
Load Change from lo= 50% to 100% of lo,max; 1µF ceramic// 10 µF tantalum						
Peak Deviation						
Settling Time (Vo<10% peak deviation)	All	ts	—	25	—	μs
(dlo/dt=2.5A/ $\mu$ s; V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C)	All	V <sub>pk</sub>	—	200	—	mV
Load Change from Io= 100% to 50% of Io,max: 1µF ceramic// 10 µF tantalum						
Peak Deviation						
Settling Time (Vo<10% peak deviation)	All	ts	—	25	—	μs

## Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Dynamic Load Response						
(dlo/dt=2.5A/ $\mu$ s; V V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C) Load Change from Io= 50% to 100% of Io,max; Co = 2x150 $\mu$ F polymer capacitors Peak Deviation	All	V <sub>pk</sub>		75	_	mV
Settling Time (Vo<10% peak deviation)	All	ts	_	100	—	μs
(dlo/dt=2.5A/ $\mu$ s; V <sub>IN</sub> = V <sub>IN, nom</sub> ; T <sub>A</sub> =25°C) Load Change from Io= 100% to 50%of Io,max: Co = 2x150 $\mu$ F polymer capacitors Peak Deviation	All	V <sub>pk</sub>	_	75		mV
Settling Time (Vo<10% peak deviation)	All	ts	—	100	—	μs

## **General Specifications**

Parameter	Min	Тур	Max	Unit
Calculated MTBF (V <sub>IN</sub> = V <sub>IN</sub> , nom, I <sub>o</sub> = 0.8I <sub>o</sub> , max, T <sub>A</sub> =40°C) Telecordia SR 332 Issue 1: Method 1, case 3	10,865,800			Hours
Weight		2.8 (0.1)	_	g (oz.)

## **Feature Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Тур	Max	Unit
On/Off Signal interface						
Device code with Suffix "4" – Positive logic						
(On/Off is open collector/drain logic input;						
Signal referenced to GND - See feature description section)						
Input High Voltage (Module ON)	All	Vін	_	_	$V_{\text{IN, max}}$	V
Input High Current	All	Ін	_	_	10	μA
Input Low Voltage (Module OFF)	All	VIL	-0.2	—	0.3	V
Input Low Current	All	lı∟	_	0.2	1	mA
Device Code with no suffix – Negative Logic						
(On/OFF pin is open collector/drain logic input with						
external pull-up resistor; signal referenced to GND)						
Input High Voltage (Module OFF)	All	Vін	2.5	_	$V_{\text{IN,max}}$	Vdc
Input High Current	All	Ін		0.2	1	mA
Input Low Voltage (Module ON)	All	VIL	-0.2	_	0.3	Vdc
Input low Current	All	lı∟		_	10	μA
Turn-On Delay and Rise Times						
$(I_{O}=I_{O, max}, V_{IN} = V_{IN, nom}, T_{A} = 25 \ ^{\circ}C, )$						
Case 1: On/Off input is set to Logic Low (Module ON) and then input power is applied (delay from instant at which $V_{IN} = V_{IN}$ min until Vo=10% of Vo,set)	All	Tdelay	—	3	—	msec
Case 2: Input power is applied for at least one second and then the On/Off input is set to logic Low (delay from instant at which Von/Off=0.3V until Vo=10% of Vo, set)	All	Tdelay	_	3	_	msec
Output voltage Rise time (time for Vo to rise from 10% of $V_{o,set}$ to 90% of Vo, set)	All	Trise	—	4	6	msec
Output voltage overshoot – Startup				_	1	% V <sub>O, set</sub>
$I_{O}\text{=}$ $I_{O,\text{ max}}\text{;}$ $V_{\text{IN}}$ = 8.3 to 14Vdc, $T_{\text{A}}$ = 25 $^{\circ}\text{C}$						
Overtemperature Protection	All	T <sub>ref</sub>	_	140	_	°C
(See Thermal Consideration section)						
Input Undervoltage Lockout						
Turn-on Threshold	All			7.9		V
Turn-off Threshold	All			7.8		V

## **Characteristic Curves**

The following figures provide typical characteristics for the Austin MiniLynx<sup>™</sup> 12 V SMT modules at 25°C.

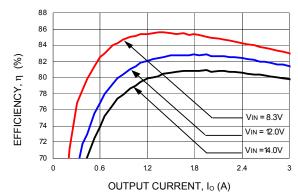


Figure 1. Converter Efficiency versus Output Current (Vout = 1.2Vdc).

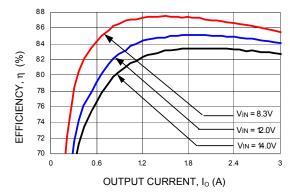


Figure 2. Converter Efficiency versus Output Current (Vout = 1.5Vdc).

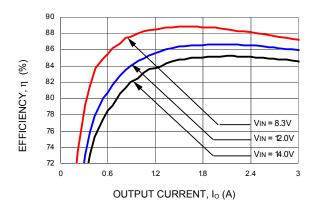


Figure 3. Converter Efficiency versus Output Current (Vout = 1.8Vdc).

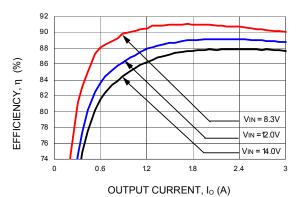


Figure 4. Converter Efficiency versus Output Current (Vout = 2.5Vdc).

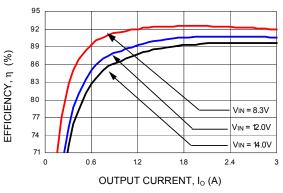
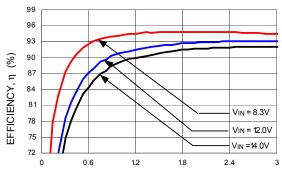
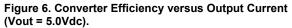


Figure 5. Converter Efficiency versus Output Current (Vout = 3.3Vdc).

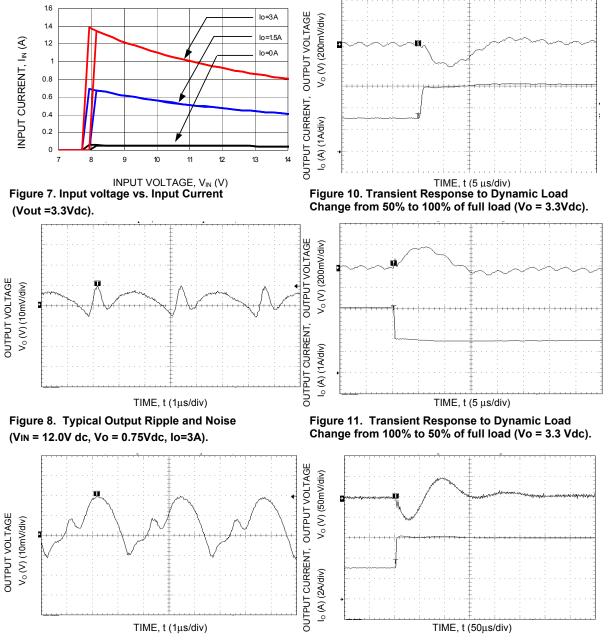


OUTPUT CURRENT, Io (A)



## Characteristic Curves (continued)

The following figures provide typical characteristics for the Austin MiniLynx<sup>™</sup> 12V SMT modules at 25°C.



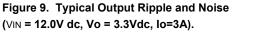
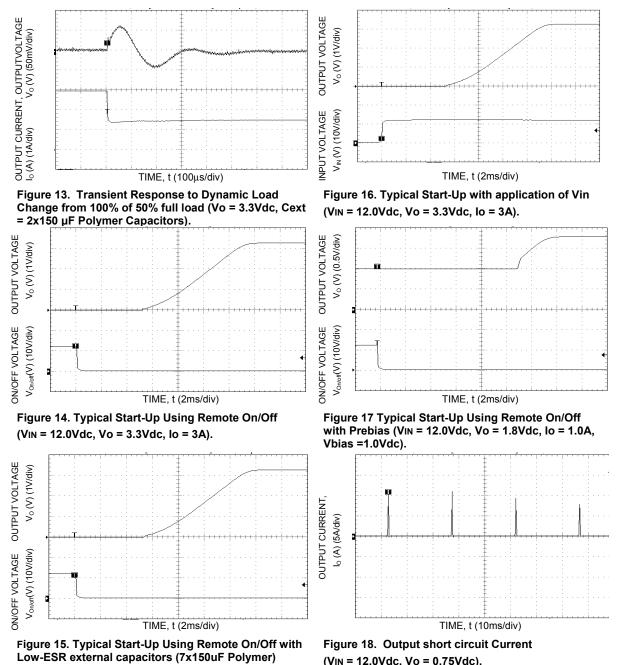


Figure 12. Transient Response to Dynamic Load Change from 50% to 100% of full load (Vo = 3.3 Vdc, Cext =  $2x150 \mu$ F Polymer Capacitors).

## Characteristic Curves (continued)

The following figures provide typical characteristics for the Austin MiniLynx<sup>™</sup> 12 V SMT modules at 25°C.



(VIN = 12.0Vdc, Vo = 0.75Vdc).

 $(V_{IN} = 12.0Vdc, Vo = 3.3Vdc, Io = 3A, Co = 1050\mu F).$ 

## Characteristic Curves (continued)

The following figures provide thermal derating curves for the Austin MiniLynx<sup>™</sup> 12 V SMT modules.

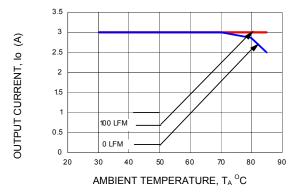


Figure 19. Derating Output Current versus Local Ambient Temperature and Airflow (VIN = 12.0 Vdc, Vo=0.75Vdc).

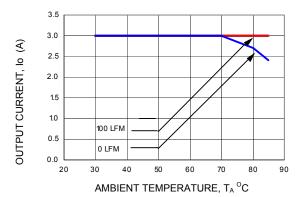


Figure 20. Derating Output Current versus Local Ambient Temperature and Airflow (VIN = 12.0Vdc, Vo=1.8 Vdc).

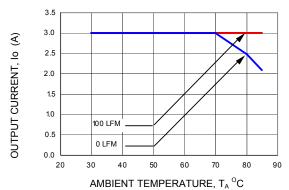


Figure 21. Derating Output Current versus Local Ambient Temperature and Airflow (VIN = 12.0Vdc, Vo=3.3 Vdc).

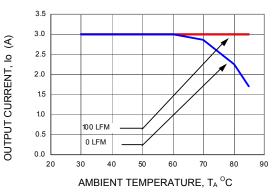
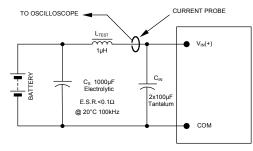


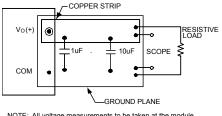
Figure 22. Derating Output Current versus Local Ambient Temperature and Airflow (VIN = 12 Vdc, Vo=5.0 Vdc).

## **Test Configurations**

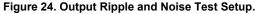


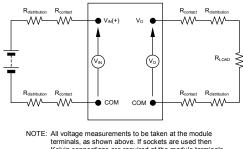
NOTE: Measure input reflected ripple current with a simulated source inductance (L<sub>TEST</sub>) of 1µH. Capacitor C<sub>S</sub> offsets possible battery impedance. Measure current as shown above

# Figure 23. Input Reflected Ripple Current Test Setup.



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.





Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

# Figure 25. Output Voltage and Efficiency Test Setup.

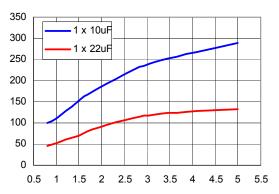
Efficiency 
$$\eta = \frac{V_0. I_0}{V_{IN}. I_{IN}} \times 100 \%$$

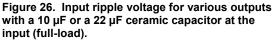
## **Design Considerations**

#### **Input Filtering**

The Austin MiniLynx<sup>TM</sup> 12V SMT module should be connected to a low-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability in the presence of inductive traces that supply input voltage to the module.

In a typical application, a 22  $\mu$ F low-ESR ceramic capacitors will be sufficient to provide adequate ripple voltage at the input of the module. To further minimize ripple voltage at the input, additional ceramic capacitors are recommended at the input of the module. Figure 26 shows input ripple voltage (mVp-p) for various outputs with 10 $\mu$ F and with a 22 $\mu$ F ceramic capacitor at full load.





## Design Considerations (continued) Output Filtering

The Austin MiniLynx<sup>TM</sup> 12 V SMT module is designed for low output ripple voltage and will meet the maximum output ripple specification with 1  $\mu$ F ceramic and 10  $\mu$ F tantalum capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table.

## **Safety Considerations**

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL 60950-1, CSA C22.2 No. 60950-1-03, and VDE 0850:2001-12 (EN60950-1) Licensed.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

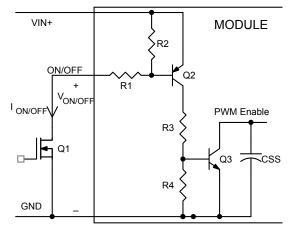
The input to these units is to be provided with a fastacting fuse with a maximum rating of 6A in the positive input lead.

## **Feature Description**

## **Remote On/Off**

Austin MiniLynx<sup>™</sup> 12V SMT power modules feature an On/Off pin for remote On/Off operation. Two On/Off logic options are available in the Austin MiniLynx<sup>™</sup> 12V series modules. Positive Logic On/Off signal, device code suffix "4", turns the module ON during a logic High on the On/Off pin and turns the module OFF during a logic Low. Negative logic On/Off signal, no device code suffix, turns the module OFF during logic High and turns the module OFF during logic High and turns the module ON during logic Low.

For positive logic modules, the circuit configuration for using the On/Off pin is shown in Figure 27. The On/Off pin is an open collector/drain logic input signal (Von/Off) that is referenced to ground. During a logichigh (On/Off pin is pulled high internal to the module) when the transistor Q1 is in the Off state, the power module is ON. Maximum allowable leakage current of the transistor when Von/off = V<sub>IN,max</sub> is 10µA. Applying a logic-low when the transistor Q1 is turned-On, the power module is OFF. During this state VOn/Off must be less than 0.3V. When not using positive logic On/off pin, leave the pin unconnected or tie to V<sub>IN</sub>.



# Figure 27. Circuit configuration for using positive logic On/OFF.

For negative logic On/Off devices, the circuit configuration is shown is Figure 28. The On/Off pin is pulled high with an external pull-up resistor (typical  $R_{pull-up} = 68k, +/-5\%$ ). When transistor Q1 is in the Off state, logic High is applied to the On/Off pin and the power module is Off. The minimum On/off voltage for logic High on the On/Off pin is 2.5 Vdc. To turn the module ON, logic Low is applied to the On/Off pin by turning ON Q1. When not using the negative logic On/Off, leave the pin unconnected or tie to GND.

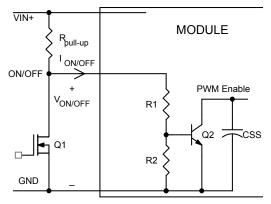


Figure 28. Circuit configuration for using negative logic On/OFF.

#### **Overcurrent Protection**

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range. The typical average output current during hiccup is 3.5A.

#### Input Undervoltage Lockout

At input voltages below the input undervoltage lockout limit, module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

#### **Overtemperature Protection**

To provide over temperature protection in a fault condition, the unit relies upon the thermal protection feature of the controller IC. The unit will shutdown if the thermal reference point  $T_{ref2}$ , (see Figure 31) exceeds 140°C (typical), but the thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. The module will automatically restarts after it cools down.

## Feature Descriptions (continued)

#### **Output Voltage Programming**

The output voltage of the Austin MiniLynx<sup>TM</sup> 12V can be programmed to any voltage from 0.75Vdc to 5.5Vdc by connecting a resistor (shown as *Rtrim* in Figure 29) between Trim and GND pins of the module. Without an external resistor between Trim and GND pins, the output of the module will be 0.7525Vdc. To calculate the value of the trim resistor, *Rtrim* for a desired output voltage, use the following equation:

$$Rtrim = \left[\frac{10500}{Vo - 0.7525} - 1000\right]\Omega$$

Rtrim is the external resistor in  $\Omega$ 

Vo is the desired output voltage

For example, to program the output voltage of the Austin MiniLynx<sup>TM</sup> 12V module to 1.8V, *Rtrim* is calculated as follows:

$$Rtrim = \left[\frac{10500}{1.8 - 0.7525} - 1000\right]$$

$$Rtrim = 9.024k\Omega$$

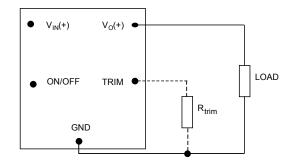


Figure 29. Circuit configuration to program output voltage using an external resistor.

Table 1 provides *Rtrim* values required for some common output voltages.

Table 4

labi	e 1
V <sub>O, set</sub> (V)	<i>Rtrim (</i> KΩ)
0.7525	Open
1.2	22.46
1.5	13.05
1.8	9.024
2.5	5.009
3.3	3.122
5.0	1.472

Using 1% tolerance trim resistor, set point tolerance of  $\pm 2\%$  is achieved as specified in the electrical specification. The POL Programming Tool, available at www.lineagepower.com under the Design Tools section, helps determine the required external trim resistor needed for a specific output voltage.

#### **Voltage Margining**

Output voltage margining can be implemented in the Austin MiniLynx<sup>TM</sup> modules by connecting a resistor, R<sub>margin-up</sub>, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R<sub>margin-down</sub>, from the Trim pin to the Output pin for margining-down. Figure 30 shows the circuit configuration for output voltage margining. The POL Programming Tool, available at

www.lineagepower.com under the Design Tools section, also calculates the values of R<sub>margin-up</sub> and R<sub>margin-down</sub> for a specific output voltage and % margin. Please consult your local Lineage Power technical representative for additional details.

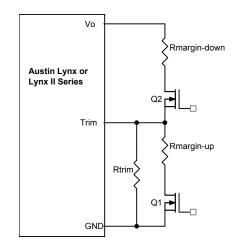


Figure 30. Circuit Configuration for margining Output voltage.

## **Thermal Considerations**

Power modules operate in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test setup is shown in Figure 32. Note that the airflow is parallel to the long axis of the module as shown in figure 31. The derating data applies to airflow in either direction of the module's long axis.

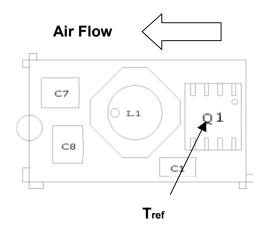


Figure 31. T<sub>ref</sub> Temperature measurement location.

The thermal reference point,  $T_{ref}$  used in the specifications is shown in Figure 32. For reliable operation this temperature should not exceed 115°C.

The output power of the module should not exceed the rated power of the module (Vo,set x lo,max).

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

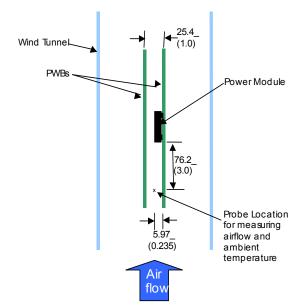


Figure 32. Thermal Test Set-up.

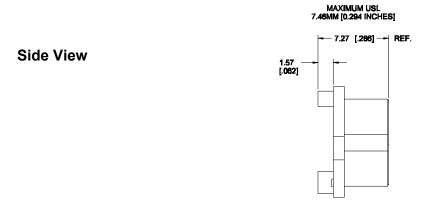
## Heat Transfer via Convection

Increased airflow over the module enhances the heat transfer via convection. Thermal derating curves showing the maximum output current that can be delivered by various module versus local ambient temperature ( $T_A$ ) for natural convection and up to 0.5m/s (100 ft./min) are shown in the Characteristics Curves section.

## **Mechanical Outline**

Dimensions are in millimeters and (inches).

Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.) 20.3 [.80] 4.83 [.190] 4.06 [.160] 4.06 [.160] 4.57 [.180] **Bottom View** TRIM GND VOUT 8.64 [.340] 8.9 [.35] 1 ON/OFF VIN 1.57 [.062] SURFACE MOUNT CONTACT 5 PLACES 1.5 1.3 [.05] [.06] 2.29 [.090] Co-planarity (max): 0.102 [0.004]



PIN	FUNCTION
1	On/Off
2	Vin
3	GND
4	Trim
5	Vout

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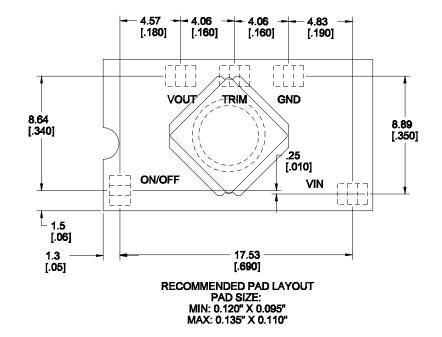
11.4 [.45]

## **Recommended Pad Layout**

Dimensions are in millimeters and (inches).

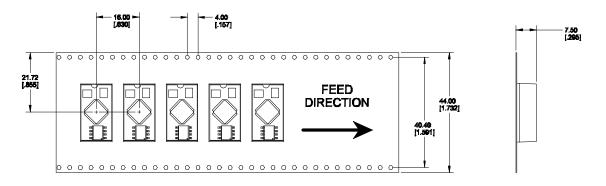
Tolerances: x.x mm  $\pm$  0.5 mm (x.xx in.  $\pm$  0.02 in.) [unless otherwise indicated] x.xx mm  $\pm$  0.25 mm (x.xxx in  $\pm$  0.010 in.)

PIN	FUNCTION
1	On/Off
2	Vin
3	GND
4	Trim
5	Vout

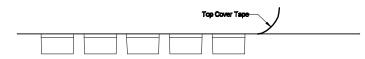


## **Packaging Details**

The Austin MiniLynx<sup>TM</sup> 12 V SMT version is supplied in tape & reel as standard. Modules are shipped in quantities of 400 modules per reel.



#### Surface Mount Tape and Reel Details



All Dimensions are in millimeters and (in inches).

## **Reel Dimensions**

Outside diameter:	330.2 mm (13.00)
Inside diameter:	177.8 mm (7.00")
Tape Width:	44.0 mm (1.73")

## **Surface Mount Information**

#### **Pick and Place**

The Austin MiniLynx<sup>™</sup> 12 V SMT modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and placing. The label meets all the requirements for surface mount processing, as well as safety standards and is able to withstand maximum reflow temperature. The label also carries product information such as product code, serial number and location of manufacture.

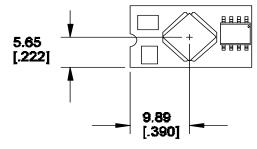


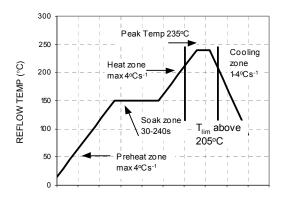
Figure 33. Pick and Place Location.

#### **Nozzle Recommendations**

The module weight has been kept to a minimum by using open frame construction. Even so, these modules have a relatively large mass when compared to conventional SMT components. Variables such as nozzle size, tip style, vacuum pressure and pick & placement speed should be considered to optimize this process. The minimum recommended nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 8 mm max.

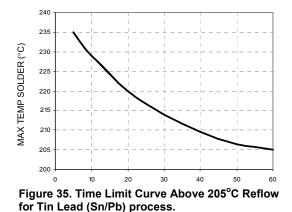
#### **Tin Lead Soldering**

The Austin MiniLynx<sup>™</sup> 12V SMT power modules are lead free modules and can be soldered either in a lead-free solder process or in a conventional Tin/Lead (Sn/Pb) process. It is recommended that the customer review data sheets in order to customize the solder reflow profile for each application board assembly. The following instructions must be observed when soldering these units. Failure to observe these instructions may result in the failure of or cause damage to the modules, and can adversely affect long-term reliability. In a conventional Tin/Lead (Sn/Pb) solder process peak reflow temperatures are limited to less than 235°C. Typically, the eutectic solder melts at 183°C, wets the land, and subsequently wicks the device connection. Sufficient time must be allowed to fuse the plating on the connection to ensure a reliable solder joint. There are several types of SMT reflow technologies currently used in the industry. These surface mount power modules can be reliably soldered using natural forced convection/IR. For reliable soldering the solder reflow profile should be established by accurately measuring the modules CP connector temperatures.



REFLOW TIME (S)





## Surface Mount Information (continued)

#### Lead Free Soldering

The –Z version Austin MiniLynx 12V SMT modules are lead-free (Pb-free) and RoHS compliant and are both forward and backward compatible in a Pb-free and a SnPb soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

#### **Pb-free Reflow Profile**

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure. 36.

#### **MSL** Rating

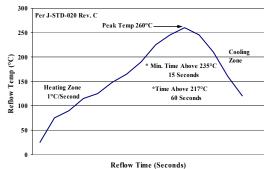
The Austin MiniLynx 12V SMT modules have a MSL rating of 2a.

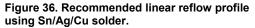
#### Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of <=  $30^{\circ}$ C and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: <  $40^{\circ}$  C, < 90% relative humidity.

#### Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to *Board Mounted Power Modules: Soldering and Cleaning* Application Note (AN04-001).





## **Ordering Information**

Please contact your Lineage Power Sales Representative for pricing, availability and optional features.

## Table 3. Device Codes

Device Code	Input Voltage	Output Voltage	Output Current	Efficiency 3.3V@ 3A	On/Off Logic	Connector Type	Comcodes
AXA003A0X-SR	8.3 - 14Vdc	0.75 - 5.5Vdc	3 A	89.0 %	Negative	SMT	108991213
AXA003A0X4-SR	8.3 - 14Vdc	0.75 – 5.5Vdc	3 A	89.0 %	Positive	SMT	108991221
AXA003A0X-SRZ	8.3 - 14Vdc	0.75 – 5.5Vdc	3 A	89.0 %	Negative	SMT	CC109101276
AXA003A0X4-SRZ	8.3 – 14Vdc	0.75 – 5.5Vdc	3 A	89.0 %	Positive	SMT	CC109102266

-Z refers to RoHS compliant Versions



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